DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 128064B SYH-PY

Product Specification

Version:4.1.1

GENERAL SPECIFICATION

MODULE NO.:

DEM 128064B SYH-PY

CUSTOMER P/N

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	15.03.2004
1	CHANGE EXTERNAL DIMENSIONS	06.04.2004
2	CHANGED PCB DRAWING AND DESCRIPTION	05.07.2004
3	ADD VERSION	28.06.2005
4	MODIFY PCB DESCRIPTION	24.03.2006
4.1.0	CHANGE IC	17.06.2008
4.1.1	CHANGE BACKLIGHT DRAWING	04.11.2008

PREPARED BY: HCL DATE: 04.11.2008

APPROVED BY: MH DATE: 11.04.2008

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1. FUNCTIONS & FEATURES

MODULE	LCD TYPE
DEM 128064B SYH-PY	STN Yellow Green Transflective Positive Mode

• Viewing Direction : 6 o'clock

• Driving Scheme : 1/64 Duty Cycle, 1/9 Bias

• Power Supply Voltage : 5.0 Volt (typ.)

• Backlight : LED, Lightguide, Yellow Green

V_{LCD} Adjustable For Best Contrast
 Display contents
 12.9 Volt (typ.)
 128 x 64 Dots

• Interface : 8 bit parallel display data from MPU

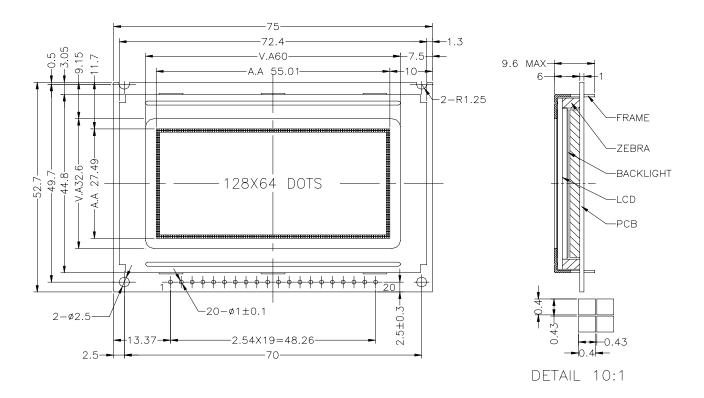
Operating Temperature : -20°C to +70°C
 Storage Temperature : -30°C to +80°C

2. MECHANICAL SPECIFICATIONS

• Module Size : 75.00 x 52.7 x 9.60 mm

Dot Size : 0.40 x 0.40 mm
 Dot Pitch : 0.43 x 0.43 mm
 Dot Gap : 0.03 mm

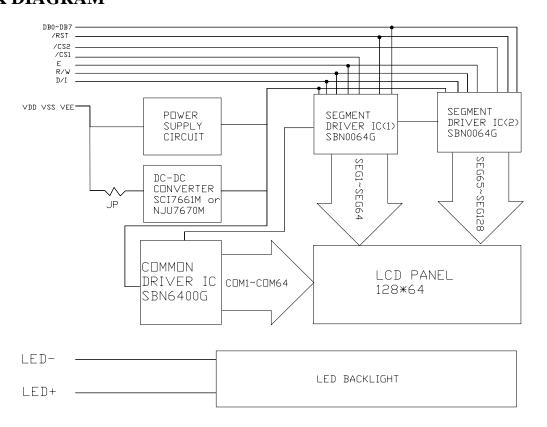
3. EXTERNAL DIMENSIONS



Remarks:

- 1. Unmarked tolerance is ± 0.3 ,
- 2. The material comply with RoHS.

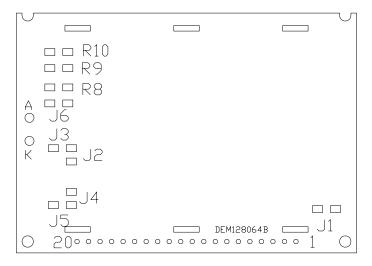
4. BLOCK DIAGRAM



5.PIN ASSIGNMENT

Pin No.	Symbol	Function
1	V _{DD}	POWER SUPPLY FOR LOGIC CIRCUIT
2	Vss	GND
3	V ₀	OPERATING VOLTAGE FOR LCD DRIVING
4	DB0	
5	DB1	
6	DB2	
7	DB3	DATE BUS.
8	DB4	Three state I/O port.
9	DB5	
10	DB6	
11	DB7	
12	CS1	Chip select signal for IC1
13	CS2	Chip select signal for IC2
14	/RST	Reset
15	R/W	H:DATA READ (LCM→ MPU)
15	K/VV	L:DATA WRITE (LCM→ MPU)
16	D/I	H:DATA INPUT;L:INSTRUCTION CODE INPUT
17	E	enable
18	VEE	POWER SUPPLY FOR LCD DRIVING
19	LED + (A)	Places refer to 6.1 drawing and description
20	LED – (K)	Please refer to 6.1 drawing and description.

5.1 PCB DRAWING AND DESCRIPTION



DESCRIPTION:

5-1-1. The polarity of the pin 19 and the pin 20:

		LED Polarity		
J3,J5	J2, J4	19 Pin	20 Pin	
Each open	Each close	Anode	Cathode	
Each close	Each open	Cathode	Anode	

Note: In application module, J3=J5=open, J2=J4=closed

5-1-2. The LED resistor can be bridged when the J6 is closed.

Note: In application module, J6=open

5-1-3. The R8, R9 and R10 are the LED resistor.

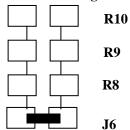
Note: In application module, R8=R9=R10=24Ohm

5-1-4. The metal-bezel is set on ground when the J1 is closed.

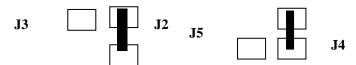
Note: In application module, J1=closed

5.2 Example application

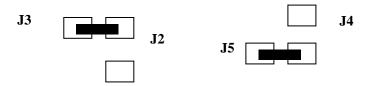
5-2-1. The LED resistor should be bridged as following.



5-2-2. The 19 pin is the anode and the 20 pin is the cathode as following.



5-2-3. The 19 pin is the cathode and the 20 pin is the anode as following.



5-2-4. The metal-bezel is ground as following.

J1

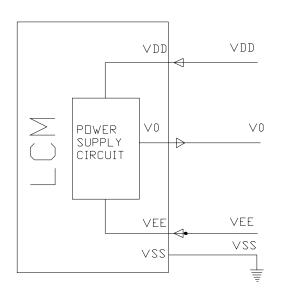
6. Absolute Maximum Ratings (Ta=25°C)

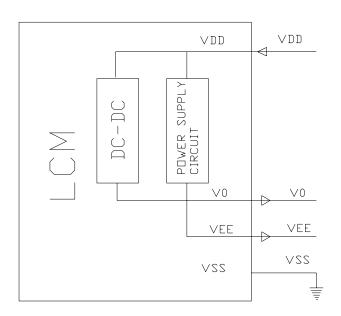
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
OPERATIONG TEMPERATURE	T_{OP}	-20		+70	°C
STORAGE TEMPERATURE	T_{ST}	-30		+80	°C
INPUT VOLTAGE	V _I	V _{SS}		V_{DD}	V
SUPPLY VOLTAGE FORLOGIC	V _{DD} - V _{SS}	-0.3		7.0	V
SUPPLY VOLTAGE FOR LCD	V _{DD} - V ₀	-0.3		19.0	V
STATIC ELECTRICITY	Be sure that you ar	e grounded wh	en handling L	CM	

7. POWER SUPPLY FOR LCD MODULE

7.1 External power supply circuit

7.2 Internal power supply circuit





 $V_{DD}\text{-}V0(V_{LCD})\text{: }LCD$ Driving voltage

 $V_{\text{DD}}\text{-}V0(V_{\text{LCD}})\text{: LCD}$ Driving voltage

8. ELECTRICAL CHARACTERISTICS

8-1 DC Characteristics (V_{DD} =+5±10% Vss=0V, Ta=-20~+70°C)

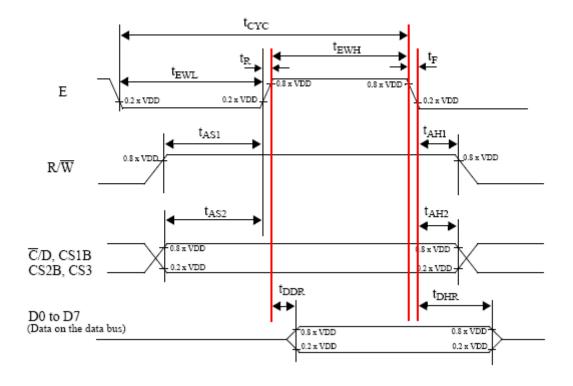
Item	Symbol	Sta	ndard Va	lue	Test	Unit
Item	By moor	MIN	TYP	MAX	Condition	Cint
Supply current for logic	$V_{ m DD}$	4.5	5.0	5.5		V
Supply current for logic	I_{DD}		2.62	4		mA
operating Voltage for LCD		13.4	14.1	14.8	-20°C	
	V_{DD} - V_0	12.2	12.9	13.6	25°C	V
		11.0	11.7	12.4	70°C	
Supply voltage for back light	V_{F}		4.2	4.6		V
Supply current back light	I_{F}		380	500	V _F =4.2V	mA
Input voltage "H" level	Vih	$0.7V_{DD}$		V_{DD}		V
Input voltage "L" level	VIL	0		$0.3V_{DD}$		V

8-2 AC Characteristics

8-2-1. AC timing for writing to the SBN0064G

(VI	- 5	<i>(7</i> .	V	- 0 M	Tamb	$= 25^{\circ}C)$
(V_D)	$=$ \circ	v :	V 99 =	= U V:	: Tamb	$= 25^{\circ}C$

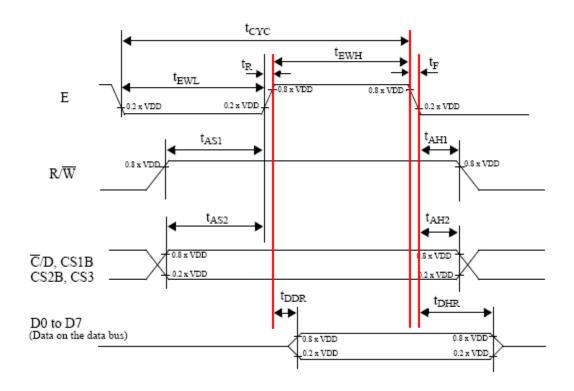
symbol	parameter	min.	max.	test conditions	unit
tcyc	Enable (E) cycle time	1000			
t _{EWL}	Enable (E) LOW width	450			1
t _{EWH}	Enable (E) HIGH width	450			1
t _R	Enable (R) rise time		20		1
t _F	Enable (F) fall time		20		1
t _{AS1}	Write set-up time	140			ns
t _{AH1}	Write hold time	10			
t _{AS2}	C/D, CS1B, CS2B, CS3 set-up time	140			
t _{AH2}	C/D, CS1B, CS2B, CS3 hold time	10			
t _{DSW}	Data setup time (on the data bus)	200		The loading on	
t _{DHW}	Data hold time (on the data bus)	10		the data bus is shown in Fig. 18.	



$\ensuremath{8\text{-}2\text{-}2\text{.}}$ AC timing for reading from the SBN0064G

 $(V_{DD} = 5 \text{ V}; V_{SS} = 0 \text{ V}; Tamb = 25^{\circ}C.)$

symbol	parameter	min.	max.	test conditions	unit
tcyc	Enable (E) cycle time	1000			
t _{EWL}	Enable (E) LOW width	450			1
t _{EWH}	Enable (E) HIGH width	450			1
t _R	Enable (R) rise time		20		1
t _F	Enable (F) fall time		20		1
t _{AS1}	READ set-up time	140			ns
t _{AH1}	READ hold time	20]'''
t _{AS2}	C/D, CS1B, CS2B, CS3 set-up time	140			1
t _{AH2}	C/D, CS1B, CS2B, CS3 hold time	10]
t _{DDR}	Data delay time (on the data bus)	320		The loading on]
t _{DHR}	Data hold time (on the data bus)	20		the data bus is shown in Fig. 18.	



9. DISPLAY CONTROL INSTRUCTION

Registers and their states after hardware RESET

The SBN0064G has 5 registers. Four of them must be programmed by the host microcontroller after hardware reset. The Status Register can be read by the host microcontroller to check the current status of the SBN0064G.

The registers and their states after RESET is given in Table 5.

Table 1 Registers and their states after RESET

Register Name	Description	States after
		RESET
Display ON/OFF Register	The Display ON/OFF Register is a 1-bit register. After RESET, its value is LOW and, therefore, the LCD display is turned OFF.	0
Display Start Line Register	The Display Start Line Register is a 6-bit register. After RESET, its value is 00 0000 and, therefore, Row 0 of the Display Data Memory is mapped to COM0 of LCD panel.	00 0000
Page Address Register	The Page Address Register is a 3-bit register. It point to a page of the Display Data Memory.	xxx
Column Address Register	The Column Address Register is a 6-bit register.	xx xxxx
Status Register	The Status Register shows the current state of the SBN0064G. It is a 3-bit register, with each bit showing the status of a programmed function.	0010 0000

9-1.Display ON/OFF and the Display ON/OFF Register

Table 2 Setting of the control bus for programming the Display ON/OFF Register

C/D	R/W
0	0

Table 3 Setting of the data bus for programming the Display ON/OFF Register

D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
0	0	1	1	1	1	1	D0

When D0=1, the code is 3F(Hex) and the display is turned ON. When D0=0, the code is 3E(Hex) and the display is turned OFF.

9-2. Display Start Line and the Display Start Line Register

Table 4 The setting of the control bus for programming the Display Start Line Register

C/D	R/W		
0	0		

Table 5 The setting of the data bus for programming the Display Start Line Register

		. 0		. ,	0		
D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
1	1	A5	A4	A3	A2	A1	A0

A5 ~ A0 are Display Start Line address bits and can be programmed with a value in the range from 0 to 63. Therefore, the code can be from 1100 0000 (C0 Hex) to 1111 1111 (FF Hex).

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9-3. Display Data Memory Page and the Page Address Register

Table 6 The setting of the control bus for programming the Page Address Register

C/D	R/W			
0	0			

Table 7 The setting of the data bus for programming the Page Address Register

D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
1	0	1	1	1	A2	A1	A0

A2, A1 and A0 are page address bits and can be programmed with a value in the range from 0 to 7. A2 A1 A0=000 selects Page 0; A2 A1 A0=001 selects Page 1; A2 A1 A0=010 selects Page 2, and A2 A1 A0=011 selects Page 3...etc.

Therefore, the code can be from 1011 1000 (B8 Hex) to 1011 1111 (BF Hex).

9-4. Column address and the Column Address Register

Table 8 The setting of the control bus for programming the Column Address Register

C/D	R/W		
0	0		

Table 9 The setting of the data bus for programming the Column Address Register

D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
0	1	A5	A4	А3	A2	A1	A0

A5~A0 are column address bits and can be programmed with a value in the range from 0 to 63. Therefore, the code can be from 0100 0000 (40 Hex) to 0111 1111 (7F Hex).

9-5. Status Read and Status Register

Table 10 The setting of the control bus for reading the Status Register

C/D	R/W			
0	1			

Table 11 The Status Register bit allocation

D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
BUSY	0	ON/OFF	RESET	0	0	0	0

Table 12 The Status Register bit description

Bit	Description
BUSY	BUSY=1 indicates that the SBN0064G is currently busy and can not accept new code or data. The SBN0064G is executing an internal operation.
	BUSY=0 indicates that the SBN0064G is not busy and is ready to accept new code or data.
ON/OFF	The ON/OFF bit indicates the current of status of display.
	If ON/OFF=0, the display has been turned ON.
	If ON/OFF=1, the display has been turned OFF.
	Note that the polarity of this bit is inverse to that of the Display ON/OFF Register.
RESET	RESET=1 indicates that the SBN0064G is currently in the process of being reset.
	RESET=0 indicates that the SBN0064G is currently in normal operation.

9-6. READ OR WRITE OPERATION TO THE DISPLAY DATA MEMORY

Table 13 READ/WRITE operation

Operation	DATA								Description
	D7	D6	D5	D4	D3	D2	D1	D0	
Write Display Data	Data to be written into the Display Data Memory.						olay D)ata	Write a byte of data to the Display Data Memory. The data to be written is put on the data bus by the host microcontroller.
Read Display Data	Data read from the Display Data Memory output latch.					ay Da	ta		Read a byte of data from the Display Data Memory. The data read from the internal 8-bit output latch (refer to Fig. 12) appears on the data bus. A dummy read is needed to get correct value.

Table 14 The setting of the control bus for Write Display Data operation

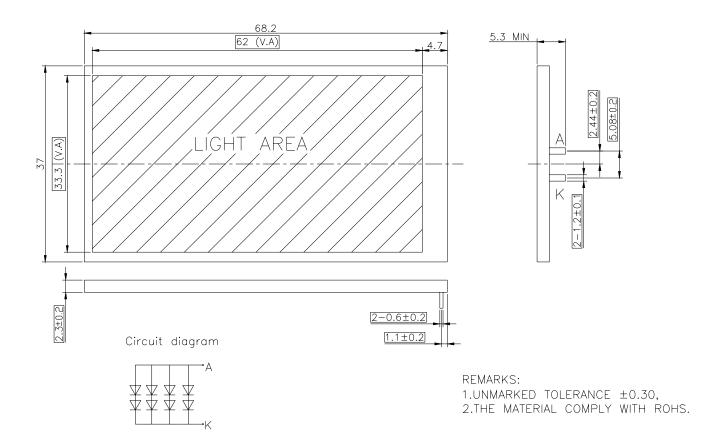
C/D	R/W		
1	0		

Table 15 The setting of the control bus for Read Display Data command

C/D	R/W
1	1

10. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS

PARAMETER	SYMBOL	MIN.	TYP,	MAX.	UNIT	TEST CONDITION	NOTE	
Supply Current	I	_	40	80	mΑ	_	_	
Forward Voltage	V _r	3.8	4,0	4.2	V	I, =40mA	_	
Reversr Voltage	٧,	ı	-	10	V	_	_	
Luminous Intensity	١,	30	40	_	cd/m³	I _F =40mA	-	
Luminous Intensity Uniformity	EH	75	_	_	%	I, =40mA	-	
LED Peak Emission Wavelength	λ,	467	571	575	Nm	I _r = 40mA	-	
Life Time	_	_	30000	20000	Hrs.	$I_r = 40 \text{mA}$	_	
Color	Yellaw Green							



11. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protective foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

■ Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0° C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

12. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections